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Part Number: 0768711301
Status: Active
Overview: QSFP+ Interconnect Solution
Description: Quad Small Form-factor Pluggable Plus (QSFP) Assembly, Stacked 2 by 1 with Elastomer Gaskets and No Light Pipes, Tin



Series image - Reference only

Documents:

Drawing (PDF)
Product Specification PS-76870-001-001 (PDF)
Application Specification AS-76870-001-001 (PDF)
Application Specification AS-76871-0002-001 (PDF)
RoHS Certificate of Compliance (PDF)

Agency Certification

UL	E29179

General

Product Family	I/O Connectors
Series	76871
Application	Module-to-Board
Component Type	Receptacle
Electrical Model	Yes
Overview	QSFP+ Interconnect Solution
Product Name	QSFP
Type	N/A
UPC	884982810846

Physical

Boot Color	N/A
Circuits (Loaded)	76
Circuits (maximum)	76
Circuits Detail	76
Durability (mating cycles max)	100
Flammability	94V-0
Gender	Female
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Net Weight	33.871/g
Number of Rows	2
Orientation	Right Angle
PC Tail Length	1.25mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.57mm
Packaging Type	Tray
Panel Mount	No
Pitch - Mating Interface	0.80mm
Pitch - Termination Interface	0.80mm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	2
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole - Compliant Pin
Waterproof / Dustproof	No

EU ELV
Not Relevant

EU RoHS | **China RoHS**
Compliant

REACH SVHC
Not Contained Per - ED/21/2016 (20 June 2016)

Halogen-Free Status
Low-Halogen

Need more information on product environmental compliance?

Email productcompliance@molex.com
Please visit the Contact Us section for any non-product compliance questions.

China ROHS	Green Image
ELV	Not Relevant
RoHS Phthalates	Not Contained

Search Parts in this Series
76871 Series

Use With
74757 , 74758

Electrical

Current - Maximum per Contact	0.5A
Grounding to Panel	None
Shield Type	EMI Gasket
Shielded	Yes
Voltage - Maximum	120V AC (RMS)/DC

Solder Process Data

Duration at Max. Process Temperature (seconds)	020
Lead-freeProcess Capability	REFLOW
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Application Specification	AS-76870-001-001, AS-76871-0002-001
Electrical Model Document	EE-76870-001
Product Specification	PS-76870-001-001
S-Parameter Model	SP-76870-001
Sales Drawing	SD-76871-1301

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